ECS Brokerage Event 2023 Country Presentations (CZ)



1. Structure of the presentation

- CZ in ECSEL / KDT JU
- Benefits for stakeholders
- CZ in Chips JU

2. Czech Republic and ECSEL / KDT JU

- CZ involved since the beginning (ARTEMIS, ENIAC, ECSEL)
- Tripartite model public funders and private companies
- Stable and coherent public support
 - 29 projects with 74 Czech partners involved (32 % of all projects have a Czech participant) => 16,7 mil. EUR of national public funding
 - 32 universities, 23 SME, 12 LE, 7 public research institutes
 - Success rate similar to other EU Member States
 - Well-established partners in the consortia
- Cooperation between academia and industry national eligibility

3. Benefits for CZ stakeholders

- Partnership with leading universities and companies from the ECS sector
- Excellent R&D&I projects with overlaps to the application
- International cooperation
- Intersectorial cooperation
- Development of new products, services and know-how
- Increase of the number of employees, development of the company, better commercialization, gain of new customers, etc.
- Increase in the number publications, connection with companies, use of the research results in education, follow-up research, etc.

4. Czech Republic and Chips JU

- What is needed to make Chips JU a success?
- Balance
 - Between old and new
 - Between research and capacity building
- Inclusion
 - Everyone is on board
 - No closed clubs
- Cooperation
 - Between all stakeholders both internationally and nationally



THANK YOU FOR YOUR ATTENTION

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